

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s)	Wang	Examiner:	Unassigned
Serial No.:	Unassigned	Group Art Unit:	Unassigned
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Filed:	Herewith	Dated:	December 15, 2003
For:	HIGH DENSITY INTEGRATED CIRCUITS AND THE METHOD OF PACKAGING THE SAME		

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

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On: December 15, 2003

Signed: Amanda F. Shaw
Amanda F. Shaw

PRELIMINARY AMENDMENT

Sir:

In advance of examination of the above-identified application, please amend the
application as follows in accordance with 37 C.F.R. §1.121.

Amendments to the Specification begin on page 2 of this paper.

Remarks/Arguments begin on page 3 of this paper.